

PHOTOCOUPLER PS2521-1,PS2521L-1

LARGE FORWARD INPUT TYPE HIGH ISOLATION VOLTAGE MULTI PHOTOCOUPLER SERIES

-NEPOC Series-

DESCRIPTION

The PS2521-1 and PS2521L-1 are optically coupled isolators containing a GaAs light emitting diode and an NPN silicon phototransistor.

The PS2521-1 is in a plastic DIP (Dual In-line Package) and the PS2521L-1 is lead bending type (Gull-wing) for surface mount.

FEATURES

- Large forward input current (IF = 150 mA)
- High Isolation voltage (BV = 5 000 Vr.m.s.)
- High collector to emitter voltage (VCEO = 80 V)
- High-speed switching (tr = 3 μ s TYP., tr = 5 μ s TYP.)
- <R> Ordering number of tape product: PS2521L-1-F3: 2 000 pcs/reel
- <R> Safety standards
 - UL approved: No. E72422
 - CSA approved: No. CA 101391 (CA5A, CAN/CSA-C22.2 60065, 60950)

APPLICATIONS

- Exchange equipment
- FAX/MODEM
- LCR adapter

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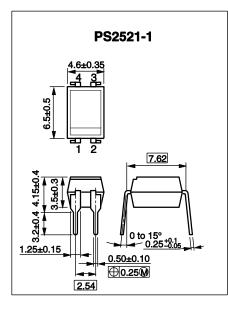
The mark <R> shows major revised points.

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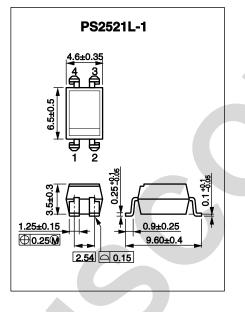
The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

<R> PACKAGE DIMENSIONS (Unit : mm)





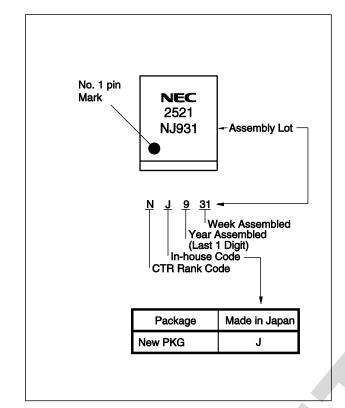
Lead Bending Type



<R> PHOTOCOUPLER CONSTRUCTION

Parameter	Unit (MIN.)		
Air Distance	7 mm		
Outer Creepage Distance	7 mm		
Inner Creepage Distance	4 mm		
Isolation Thickness	0.4 mm		

<R> MARKING EXAMPLE



<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
PS2521-1	PS2521-1-A	Pb-Free	Magazine case 100 pcs	Standard products	PS2521-1
PS2521L-1	PS2521L-1-A			(UL, CSA Approved)	
PS2521L-1-F3	PS2521L-1-F3-A		Embossed Tape 2 000 pcs/reel		

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

	Parameter	Symbol	Ratings	Unit
Diode	Forward Current (DC)	lF	150	mA
	Reverse Voltage	VR	6.0	V
	Power Dissipation Derating	⊿Po/°C	2.5	mW/°C
	Power Dissipation	PD	250	mW
	Peak Forward Current *1	IFP	1	А
Transistor	Collector to Emitter Voltage	Vceo	80	V
	Emitter to Collector Voltage	Veco	6	V
	Collector Current		50	mA
	Power Dissipation Derating	⊿Pc/°C	1.5	mW/°C
	Power Dissipation	Pc	150	mW
Isolation Voltage ^{*2}		BV	5 000	Vr.m.s.
Operating A	Ambient Temperature	ΤΑ	-55 to +100	°C
Storage Te	mperature	Tstg	-55 to +150	°C

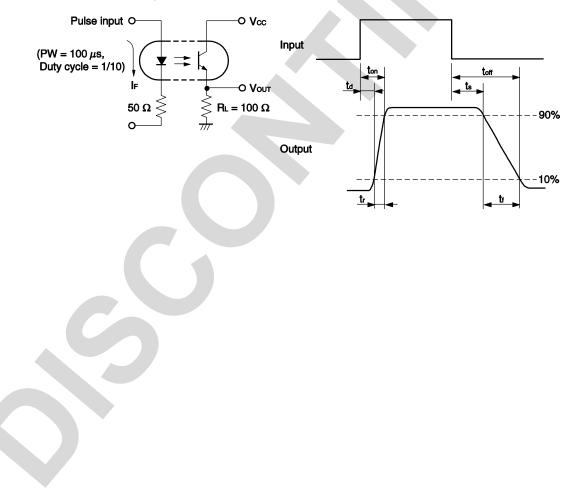
***1** PW = 100 *µ*s, Duty Cycle = 1%

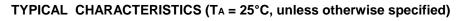
*2 AC voltage for 1 minute at $T_A = 25^{\circ}$ C, RH = 60% between input and output. Pins 1-2 shorted together, 3-4 shorted together.

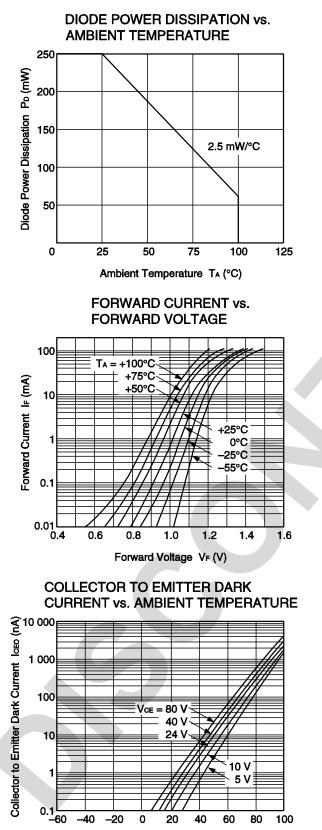
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 100 mA		1.3	1.7	V
	Reverse Current	IR	V _R = 5 V			5	μA
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		70		pF
Transistor	Collector to Emitter Dark Current	Iceo	Vce = 80 V, IF = 0 mA			100	nA
Coupled	Current Transfer Ratio (Ic/IF)	CTR	$I_F = 100 \text{ mA}, \text{ V}_{CE} = 3 \text{ V}$	20		80	%
	Collector Saturation Voltage	VCE (sat)	I⊧ = 100 mA, Ic = 4 mA			0.3	V
	Isolation Resistance	Ri-o	VI-O = 1.0 kVDC	10 ¹¹			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1.0 MHz		0.6		pF
	Rise Time ^{*1}	tr	Vcc = 10 V, Ic = 2 mA, R∟ = 100 Ω		3		μS
	Fall Time ^{*1}	tr			5		

ELECTRICAL CHARACTERISTICS (TA = 25°C)

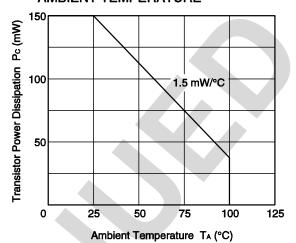
*1 Test circuit for switching time



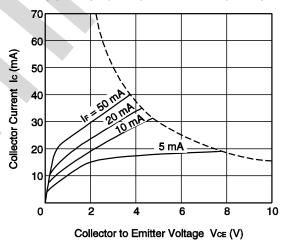




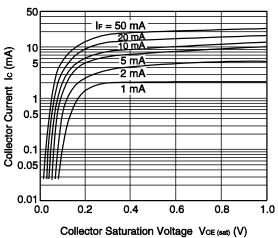
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



COLLECTOR CURRENT vs. COLLECTOR SATURATION VOLTAGE



Remark The graphs indicate nominal characteristics.

20

Ambient Temperature TA (°C)

40

60

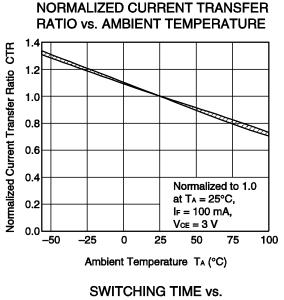
80

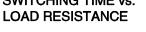
100

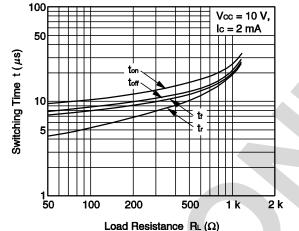
-40

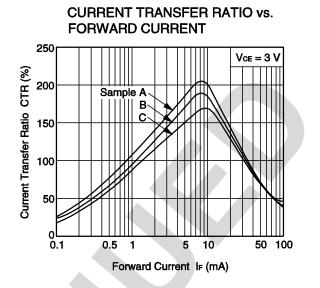
-20

0

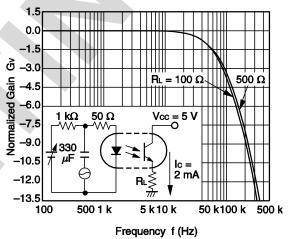


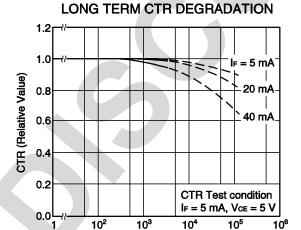






FREQUENCY RESPONSE





Time (Hr)

10⁴

10⁵

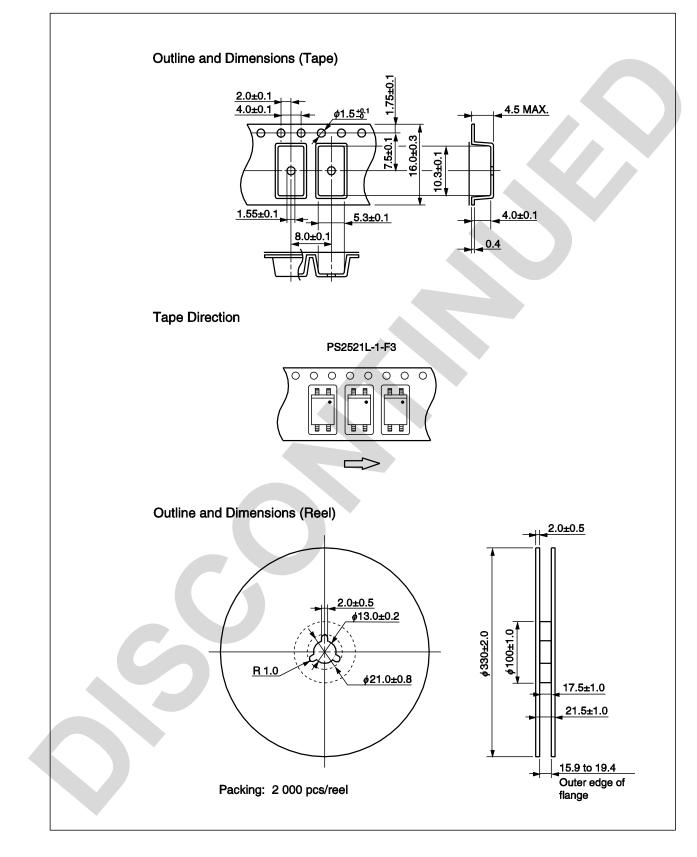
10⁶

10³

10²

Remark The graphs indicate nominal characteristics.

<R> TAPING SPECIFICATIONS (Unit : mm)



NOTES ON HANDLING

1. Recommended soldering conditions

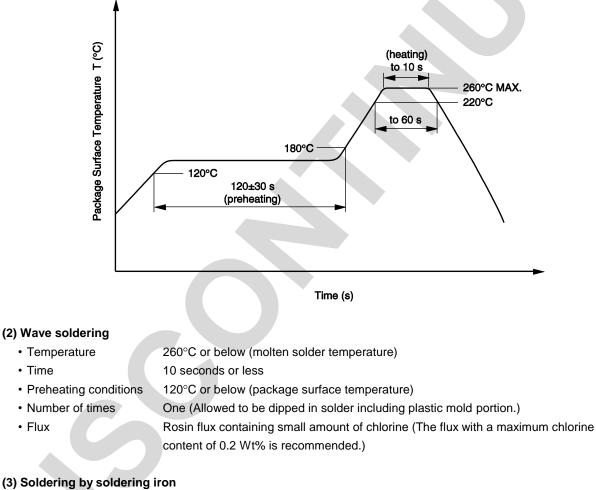
(1) Infrared reflow soldering

- · Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Peak temperature (lead part temperature) Time (each pins) Flux Seconds or less Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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M8E0904E

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or i any way allow it to enter the mouth.